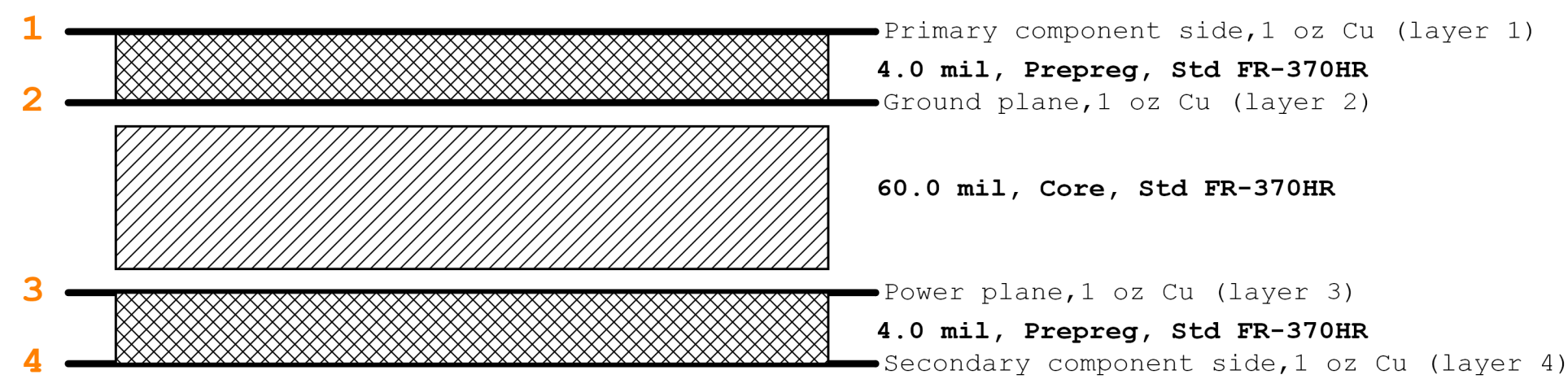


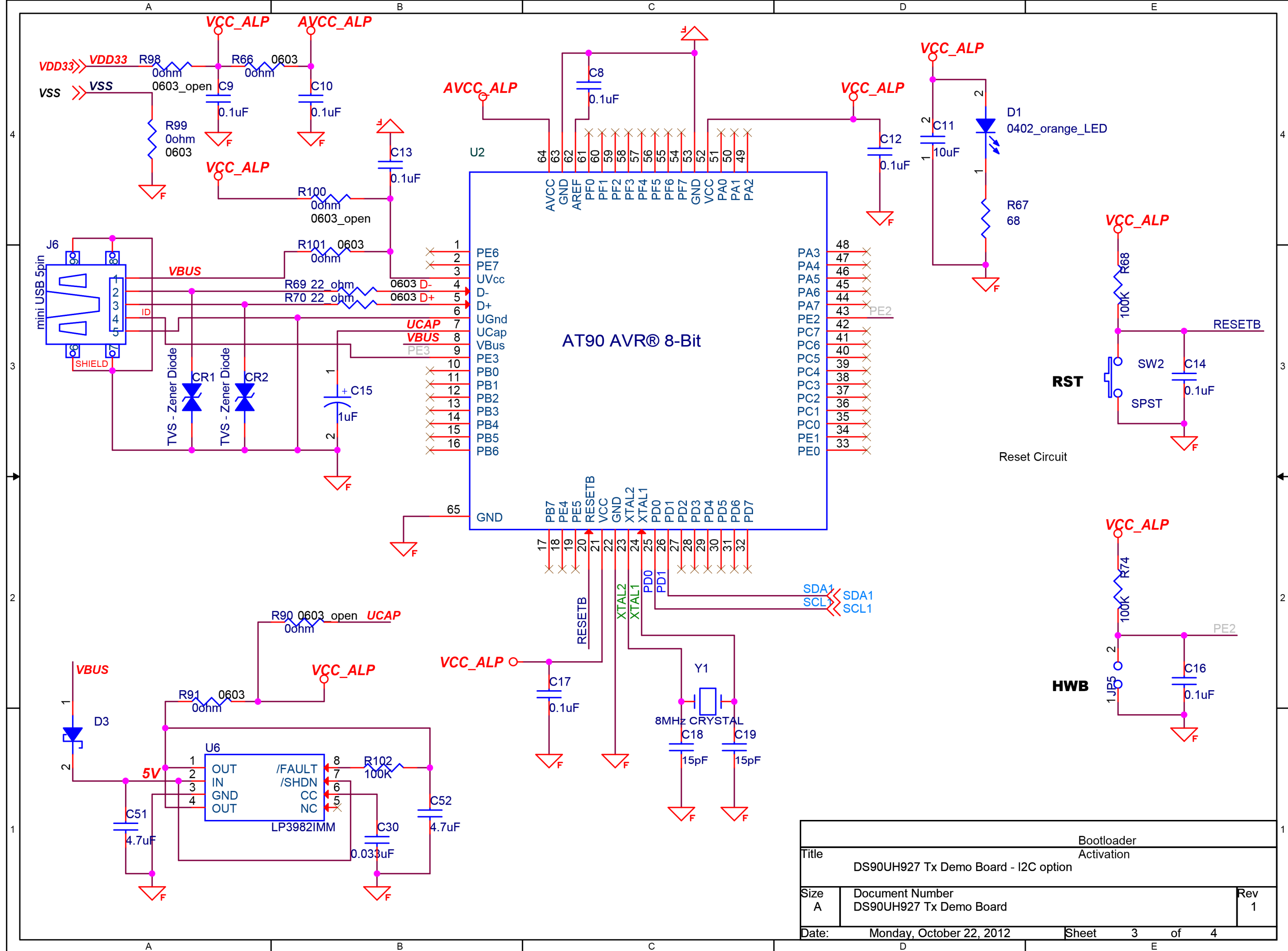


LAYOUT NOTES:
1) 4 layer board.
2) Use standard FR-4
3) 5% impedance tolerance.
4) Minimum 4 standoffs on each corner of board. (0.156 X 4).



 Core Material
 Prepreg Material

Title			
DS90UH927 Tx Demo Board - Board Stackup			
Size A	Document Number		Rev 1
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Bootloader Activation		
TitleDS90UH927 Tx Demo Board - I2C option		
SizeA	Document Number	Rev1
	DS90UH927 Tx Demo Board	
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